

# TXB0104 4-Bit Bidirectional Voltage-level Translator With Automatic Direction Sensing and $\pm 15$ -kV ESD Protection

## 1 Features

- 1.2-V to 3.6-V on A Port and 1.65-V to 5.5-V on B Port ( $V_{CCA} \leq V_{CCB}$ )
- $V_{CC}$  Isolation Feature: If Either  $V_{CC}$  Input Is at GND, All Outputs Are in the High-Impedance State
- Output Enable (OE) Input Circuit Referenced to  $V_{CCA}$
- Low Power Consumption, 5- $\mu$ A Maximum  $I_{CC}$
- $I_{OFF}$  Supports Partial Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
  - A Port:
    - 2500-V Human-Body Model (A114-B)
    - 1500-V Charged-Device Model (C101)
  - B Port:
    - $\pm 15$ -kV Human-Body Model (A114-B)
    - 1500-V Charged-Device Model (C101)

## 2 Applications

- Headsets
- Smartphones
- Tablets
- Desktop PC

## 3 Description

This TXB0104 4-bit noninverting translator uses two separate configurable power-supply rails. The A port is designed to track  $V_{CCA}$ .  $V_{CCA}$  accepts any supply voltage from 1.2 V to 3.6 V. The B port is designed to track  $V_{CCB}$ .  $V_{CCB}$  accepts any supply voltage from 1.65 V to 5.5 V. This allows for universal low-voltage bidirectional translation between any of the 1.2-V, 1.5-V, 1.8-V, 2.5-V, 3.3-V, and 5-V voltage nodes.  $V_{CCA}$  must not exceed  $V_{CCB}$ .

When the OE input is low, all outputs are placed in the high-impedance state. To ensure the high-impedance state during power up or power down, OE must be tied to GND through a pulldown resistor. The current sourcing capability of the driver determines the minimum value of the resistor.

The TXB0104 device is designed so the OE input circuit is supplied by  $V_{CCA}$ .

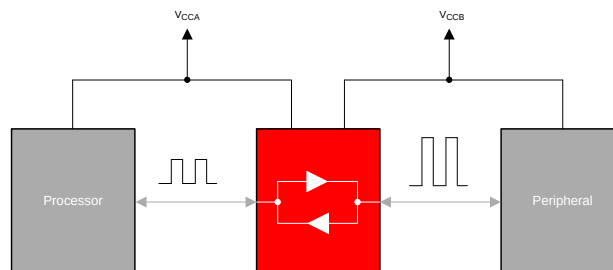
This device is fully specified for partial power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the outputs, which prevents damaging current backflow through the device when the device is powered down.

### Device Information<sup>(1)</sup>

| PART NUMBER    | PACKAGE                    | BODY SIZE (NOM)          |
|----------------|----------------------------|--------------------------|
| TXB0104RUT     | UQFN (12)                  | 2.00 mm $\times$ 1.70 mm |
| TXB0104D       | SOIC (14)                  | 8.65 mm $\times$ 3.91 mm |
| TXB0104ZXU/GXU | BGA MICROSTAR JUNIOR™ (12) | 2.00 mm $\times$ 2.50 mm |
| TXB0104PW      | TSSOP (14)                 | 5.00 mm $\times$ 4.40 mm |
| TXB0104RGY     | VQFN (14)                  | 3.50 mm $\times$ 3.50 mm |
| TXB0104YZT     | DSBGA (12)                 | 1.40 mm $\times$ 1.90 mm |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

### Typical Application Block Diagram for TXB010X



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## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

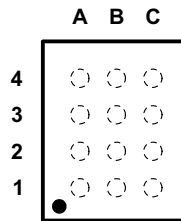
| Changes from Revision H (January 2018) to Revision I               | Page      |
|--------------------------------------------------------------------|-----------|
| • Updated <i>Pin Functions</i> table .....                         | <b>4</b>  |
| • Added <i>Pin Assignments</i> table for GXU and ZXU package ..... | <b>4</b>  |
| • Added <i>Pin Assignments</i> table for YZT package .....         | <b>4</b>  |
| • Updated <i>Layout Example</i> .....                              | <b>22</b> |

| Changes from Revision G (November 2014) to Revision H                                                       | Page     |
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| • Added package families to package pinout drawings in <i>Pin Configuration and Functions</i> section ..... | <b>3</b> |
| • Added junction temperature range in <i>Absolute Maximum Rating</i> table .....                            | <b>5</b> |
| • Changed unit from V to kV in <i>ESD Ratings</i> table .....                                               | <b>5</b> |

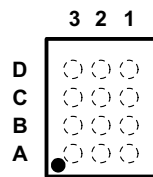
| Changes from Revision F (May 2012) to Revision G                                                                                                                                                                                                                                                                                                                                                         | Page     |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|
| • Added <i>Pin Configuration and Functions</i> section, <i>Handling Rating</i> table, <i>Feature Description</i> section, <i>Device Functional Modes</i> , <i>Application and Implementation</i> section, <i>Power Supply Recommendations</i> section, <i>Layout</i> section, <i>Device and Documentation Support</i> section, and <i>Mechanical, Packaging, and Orderable Information</i> section ..... | <b>1</b> |

## 5 Pin Configuration and Functions

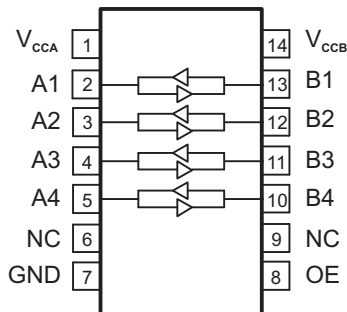
**GXU and ZXU Package**  
12-Pin BGA Microstar Junior  
Top View



**YZT Package**  
12-Pin DSBGA  
Top View

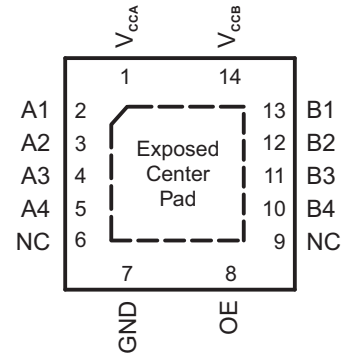


**D or PW Package**  
14-Pin SOIC or TSSOP  
Top View



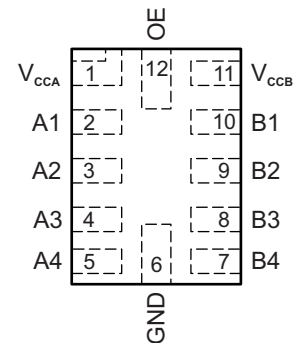
NC – No internal connection

**RGY Package**  
14-Pin VQFN With Exposed Thermal Pad  
Top View



NC – No internal connection

**RUT Package**  
12-Pin UQFN  
Top View



### Pin Functions

| NAME        | PIN   |     |     |          |     | I/O | DESCRIPTION                                                                                                       |
|-------------|-------|-----|-----|----------|-----|-----|-------------------------------------------------------------------------------------------------------------------|
|             | D, PW | RGY | RUT | GXU, ZXU | YZT |     |                                                                                                                   |
| A1          | 2     | 2   | 2   | A1       | A3  | I/O | Input/output 1. Referenced to $V_{CCA}$ .                                                                         |
| A2          | 3     | 3   | 3   | A2       | B3  | I/O | Input/output 2. Referenced to $V_{CCA}$ .                                                                         |
| A3          | 4     | 4   | 4   | A3       | C3  | I/O | Input/output 3. Referenced to $V_{CCA}$ .                                                                         |
| A4          | 5     | 5   | 5   | A4       | D3  | I/O | Input/output 4. Referenced to $V_{CCA}$ .                                                                         |
| B1          | 13    | 13  | 10  | C1       | A1  | I/O | Input/output 1. Referenced to $V_{CCB}$ .                                                                         |
| B2          | 12    | 12  | 9   | C2       | B1  | I/O | Input/output 2. Referenced to $V_{CCB}$ .                                                                         |
| B3          | 11    | 11  | 8   | C3       | C1  | I/O | Input/output 3. Referenced to $V_{CCB}$ .                                                                         |
| B4          | 10    | 10  | 7   | C4       | D1  | I/O | Input/output 4. Referenced to $V_{CCB}$ .                                                                         |
| GND         | 7     | 7   | 6   | B4       | D2  | —   | Ground                                                                                                            |
| NC          | 6, 9  | 6,9 | —   | —        | —   | —   | No connection. Not internally connected.                                                                          |
| OE          | 8     | 8   | 12  | B3       | C2  | I   | Tri-state output-mode enable. Pull OE low to place all outputs in tri-state mode. Referenced to $V_{CCA}$ .       |
| $V_{CCA}$   | 1     | 1   | 1   | B2       | B2  | —   | A-port supply voltage $1.2\text{ V} \leq V_{CCA} \leq 3.6\text{ V}$ and $V_{CCA} \leq V_{CCB}$ .                  |
| $V_{CCB}$   | 14    | 14  | 11  | B1       | A2  | —   | B-port supply voltage $1.65\text{ V} \leq V_{CCB} \leq 5.5\text{ V}$ .                                            |
| Thermal pad | —     | —   | —   | —        | —   | —   | For the RGY package, the exposed center thermal pad must either be connected to Ground or left electrically open. |

### Pin Assignments: GXU and ZXU Package

|   | A  | B         | C  |
|---|----|-----------|----|
| 4 | A4 | GND       | B4 |
| 3 | A3 | OE        | B3 |
| 2 | A2 | $V_{CCA}$ | B2 |
| 1 | A1 | $V_{CCB}$ | B1 |

### Pin Assignments: YZT Package

|   | 3  | 2         | 1  |
|---|----|-----------|----|
| D | A4 | GND       | B4 |
| C | A3 | OE        | B3 |
| B | A2 | $V_{CCA}$ | B2 |
| A | A1 | $V_{CCB}$ | B1 |

## 6 Specifications

### 6.1 Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                                                                               |           | MIN  | MAX             | UNIT |
|-------------------------------------------------------------------------------|-----------|------|-----------------|------|
| Supply voltage, $V_{CCA}$                                                     |           | –0.5 | 4.6             | V    |
| Supply voltage, $V_{CCB}$                                                     |           | –0.5 | 6.5             |      |
| Input voltage, $V_I$                                                          | A port    | –0.5 | 4.6             | V    |
|                                                                               | B port    | –0.5 | 6.5             |      |
| Voltage applied to any output in the high-impedance or power-off state, $V_O$ | A port    | –0.5 | 4.6             | V    |
|                                                                               | B port    | –0.5 | 6.5             |      |
| Voltage applied to any output in the high or low state, $V_O^{(2)}$           | A port    | –0.5 | $V_{CCA} + 0.5$ | V    |
|                                                                               | B port    | –0.5 | $V_{CCB} + 0.5$ |      |
| Input clamp current, $I_{IK}$                                                 | $V_I < 0$ |      | –50             | mA   |
| Output clamp current, $I_{OK}$                                                | $V_O < 0$ |      | –50             | mA   |
| Continuous output current, $I_O$                                              |           | –50  | 50              | mA   |
| Continuous current through $V_{CCA}$ , $V_{CCB}$ , or GND                     |           | –100 | 100             | mA   |
| Junction temperature range, $T_J$                                             |           |      | 150             | °C   |
| Storage temperature range, $T_{stg}$                                          |           | –65  | 150             | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The value of  $V_{CCA}$  and  $V_{CCB}$  are provided in the recommended operating conditions table.

### 6.2 ESD Ratings

|                                     |                                                                                |        | VALUE | UNIT |
|-------------------------------------|--------------------------------------------------------------------------------|--------|-------|------|
| $V_{(ESD)}$ Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | A port | ±2.5  | kV   |
|                                     | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | B port | ±15   |      |
|                                     | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | A port | ±1.5  |      |
|                                     | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | B port | ±1.5  |      |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)<sup>(1)(2)</sup>

|                  |                                                                        |               |                                                                         | MIN                                    | MAX                                    | UNIT |
|------------------|------------------------------------------------------------------------|---------------|-------------------------------------------------------------------------|----------------------------------------|----------------------------------------|------|
| V <sub>CCA</sub> | Supply voltage                                                         |               |                                                                         | 1.2                                    | 3.6                                    | V    |
| V <sub>CCB</sub> | Supply voltage                                                         |               |                                                                         | 1.65                                   | 5.5                                    |      |
| V <sub>IH</sub>  | High-level input voltage                                               | Data inputs   | V <sub>CCA</sub> = 1.2 V to 3.6 V<br>V <sub>CCB</sub> = 1.65 V to 5.5 V | V <sub>CCI</sub> × 0.65 <sup>(3)</sup> | V <sub>CCI</sub>                       | V    |
|                  |                                                                        | OE            | V <sub>CCA</sub> = 1.2 V to 3.6 V<br>V <sub>CCB</sub> = 1.65 V to 5.5 V | V <sub>CCA</sub> × 0.65                | 5.5                                    |      |
| V <sub>IL</sub>  | Low-level input voltage                                                | Data inputs   | V <sub>CCA</sub> = 1.2 V to 5.5 V<br>V <sub>CCB</sub> = 1.65 V to 5.5 V | 0                                      | V <sub>CCI</sub> × 0.35 <sup>(3)</sup> | V    |
|                  |                                                                        | OE            | V <sub>CCA</sub> = 1.2 V to 3.6 V<br>V <sub>CCB</sub> = 1.65 V to 5.5 V | 0                                      | V <sub>CCA</sub> × 0.35                |      |
| V <sub>O</sub>   | Voltage applied to any output in the high-impedance or power-off state | A-port        | V <sub>CCA</sub> = 1.2 V to 3.6 V<br>V <sub>CCB</sub> = 1.65 V to 5.5 V | 0                                      | 3.6                                    | V    |
|                  |                                                                        | B-port        | V <sub>CCA</sub> = 1.2 V to 3.6 V<br>V <sub>CCB</sub> = 1.65 V to 5.5 V | 0                                      | 5.5                                    |      |
| Δt/Δv            | Input transition rise or fall rate                                     | A-port inputs | V <sub>CCA</sub> = 1.2 V to 3.6 V<br>V <sub>CCB</sub> = 1.65 V to 5.5 V | 40                                     |                                        | ns/V |
|                  |                                                                        | B-port inputs | V <sub>CCA</sub> = 1.2 V to 3.6 V                                       | V <sub>CCB</sub> = 1.65 V to 3.6 V     | 40                                     |      |
|                  |                                                                        |               |                                                                         | V <sub>CCB</sub> = 4.5 V to 5.5 V      | 30                                     |      |
| T <sub>A</sub>   | Operating free-air temperature                                         |               |                                                                         | −40                                    | 85                                     | °C   |

(1) The A and B sides of an unused data I/O pair must be held in the same state, that is, both at V<sub>CCI</sub> or both at GND.

(2) V<sub>CCA</sub> must be less than or equal to V<sub>CCB</sub> and must not exceed 3.6 V.

(3) V<sub>CCI</sub> is the supply voltage associated with the input port.

### 6.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | TXB0104 |         |         |         |         |         | UNIT |
|-------------------------------|----------------------------------------------|---------|---------|---------|---------|---------|---------|------|
|                               |                                              | D       | GXU/ZXU | PW      | RGY     | RUT     | YZT     |      |
|                               |                                              | 14 PINS | 12 PINS | 14 PINS | 14 PINS | 12 PINS | 12 PINS |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 90.7    | 127.1   | 121.0   | 52.8    | 119.8   | 89.2    | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 50.5    | 92.8    | 50.0    | 67.7    | 42.6    | 0.9     |      |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 45.4    | 62.2    | 62.8    | 28.9    | 52.5    | 14.4    |      |
| ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 14.7    | 2.3     | 6.4     | 2.6     | 0.7     | 3.0     |      |
| ψ <sub>JB</sub>               | Junction-to-board characterization parameter | 45.1    | 62.2    | 62.2    | 29.0    | 52.3    | 14.4    |      |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance | —       | —       | —       | —       | —       | —       |      |

(1) For more information about traditional and new thermal metrics, see the [IC Package Thermal Metrics](#) application report.

## 6.5 Electrical Characteristics<sup>(1)(2)</sup>

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER                           |                                                       | TEST CONDITIONS                                                             | V <sub>CCA</sub> | V <sub>CCB</sub> | T <sub>A</sub> = 25°C |     |     | –40°C to 85°C          |     | UNIT |
|-------------------------------------|-------------------------------------------------------|-----------------------------------------------------------------------------|------------------|------------------|-----------------------|-----|-----|------------------------|-----|------|
|                                     |                                                       |                                                                             |                  |                  | MIN                   | TYP | MAX | MIN                    | MAX |      |
| V <sub>OHA</sub>                    | Port A output high voltage                            | I <sub>OH</sub> = –20 μA                                                    | 1.2 V            |                  | 1.1                   |     |     |                        |     | V    |
|                                     |                                                       |                                                                             | 1.4 V to 3.6 V   |                  |                       |     |     | V <sub>CCA</sub> – 0.4 |     |      |
| V <sub>OLA</sub>                    | Port A output low voltage                             | I <sub>OL</sub> = 20 μA                                                     | 1.2 V            |                  | 0.3                   |     |     |                        |     | V    |
|                                     |                                                       |                                                                             | 1.4 V to 3.6 V   |                  |                       |     |     | 0.4                    |     |      |
| V <sub>OHB</sub>                    | Port B output high voltage                            | I <sub>OH</sub> = –20 μA                                                    |                  | 1.65 V to 5.5 V  |                       |     |     | V <sub>CCB</sub> – 0.4 |     | V    |
| V <sub>OLB</sub>                    | Port B output low voltage                             | I <sub>OL</sub> = 20 μA                                                     |                  | 1.65 V to 5.5 V  |                       |     |     | 0.4                    |     | V    |
| I <sub>I</sub>                      | Inflection-point current                              | OE:<br>V <sub>I</sub> = V <sub>CCI</sub> or GND                             | 1.2 V to 3.6 V   | 1.65 V to 5.5 V  | –1                    |     | 1   | –2                     | 2   | μA   |
| I <sub>off</sub>                    | Off-state current                                     | A port:<br>V <sub>I</sub> or V <sub>O</sub> = 0 to 3.6 V                    | 0 V              | 0 V to 5.5 V     | –1                    |     | 1   | –2                     | 2   | μA   |
|                                     |                                                       | B port:<br>V <sub>I</sub> or V <sub>O</sub> = 0 to 5.5 V                    | 0 V to 3.6 V     | 0 V              | –1                    |     | 1   | –2                     | 2   |      |
| I <sub>OZ</sub>                     | High-impedance-state output current                   | A or B port:<br>OE = GND                                                    | 1.2 V to 3.6 V   | 1.65 V to 5.5 V  | –1                    |     | 1   | –2                     | 2   | μA   |
| I <sub>CCA</sub>                    | V <sub>CCA</sub> supply current                       | V <sub>I</sub> = V <sub>CCI</sub> or GND<br>I <sub>O</sub> = 0              | 1.2 V            | 1.65 V to 5.5 V  | 0.06                  |     |     |                        |     | μA   |
|                                     |                                                       |                                                                             | 1.4 V to 3.6 V   | 1.65 V to 5.5 V  |                       |     |     | 5                      |     |      |
|                                     |                                                       |                                                                             | 3.6 V            | 0 V              |                       |     |     | 2                      |     |      |
|                                     |                                                       |                                                                             | 0 V              | 5.5 V            |                       |     |     | –2                     |     |      |
| I <sub>CCB</sub>                    | V <sub>CCB</sub> supply current                       | V <sub>I</sub> = V <sub>CCI</sub> or GND<br>I <sub>O</sub> = 0              | 1.2 V            | 1.65 V to 5.5 V  | 3.4                   |     |     |                        |     | μA   |
|                                     |                                                       |                                                                             | 1.4 V to 3.6 V   | 1.65 V to 5.5 V  |                       |     |     | 5                      |     |      |
|                                     |                                                       |                                                                             | 3.6 V            | 0 V              |                       |     |     | –2                     |     |      |
|                                     |                                                       |                                                                             | 0 V              | 5.5 V            |                       |     |     | 2                      |     |      |
| I <sub>CCA</sub> + I <sub>CCB</sub> | Combined supply current                               | V <sub>I</sub> = V <sub>CCI</sub> or GND<br>I <sub>O</sub> = 0              | 1.2 V            | 1.65 V to 5.5 V  | 3.5                   |     |     |                        |     | μA   |
|                                     |                                                       |                                                                             | 1.4 V to 3.6 V   | 1.65 V to 5.5 V  |                       |     |     | 10                     |     |      |
| I <sub>CCZA</sub>                   | High-impedance state, V <sub>CCA</sub> supply current | V <sub>I</sub> = V <sub>CCI</sub> or GND<br>I <sub>O</sub> = 0,<br>OE = GND | 1.2 V            | 1.65 V to 5.5 V  | 0.05                  |     |     |                        |     | μA   |
|                                     |                                                       |                                                                             | 1.4 V to 3.6 V   | 1.65 V to 5.5 V  |                       |     |     | 5                      |     |      |
| I <sub>CCZB</sub>                   | High-impedance state, V <sub>CCB</sub> supply current | V <sub>I</sub> = V <sub>CCI</sub> or GND<br>I <sub>O</sub> = 0,<br>OE = GND | 1.2 V            | 1.65 V to 5.5 V  | 3.3                   |     |     |                        |     | μA   |
|                                     |                                                       |                                                                             | 1.4 V to 3.6 V   | 1.65 V to 5.5 V  |                       |     |     | 5                      |     |      |
| C <sub>i</sub>                      | Input capacitance                                     | OE                                                                          | 1.2 V to 3.6 V   | 1.65 V to 5.5 V  | 3                     |     |     | 4                      |     | pF   |
| C <sub>io</sub>                     | Input-to-output internal capacitance                  | A port                                                                      | 1.2 V to 3.6 V   | 1.65 V to 5.5 V  | 5                     |     |     | 6                      |     | pF   |
|                                     |                                                       | B port                                                                      | 1.2 V to 3.6 V   | 1.65 V to 5.5 V  | 11                    |     |     | 14                     |     |      |

(1) V<sub>CCI</sub> is the supply voltage associated with the input port.

(2) V<sub>CCO</sub> is the supply voltage associated with the output port.

## 6.6 Timing Requirements: $V_{CCA} = 1.2\text{ V}$

 $T_A = 25^\circ\text{C}$ ,  $V_{CCA} = 1.2\text{ V}$ 

|           |                |             | $V_{CCB} = 1.8\text{ V}$ |     |     | $V_{CCB} = 2.5\text{ V}$ |     |     | $V_{CCB} = 3.3\text{ V}$ |     |     | $V_{CCB} = 5\text{ V}$ |     |     | UNIT |
|-----------|----------------|-------------|--------------------------|-----|-----|--------------------------|-----|-----|--------------------------|-----|-----|------------------------|-----|-----|------|
|           |                |             | MIN                      | TYP | MAX | MIN                      | TYP | MAX | MIN                      | TYP | MAX | MIN                    | TYP | MAX |      |
| Data rate |                |             | 20                       |     |     | 20                       |     |     | 20                       |     |     | 20                     |     |     | Mbps |
| $t_w$     | Pulse duration | Data inputs | 50                       |     |     | 50                       |     |     | 50                       |     |     | 50                     |     |     | ns   |

## 6.7 Timing Requirements: $V_{CCA} = 1.5\text{ V} \pm 0.1\text{ V}$

over recommended operating free-air temperature range,  $V_{CCA} = 1.5\text{ V} \pm 0.1\text{ V}$  (unless otherwise noted)

|           |                |             | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ |     | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ |     | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ |     | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ |     | UNIT |
|-----------|----------------|-------------|--------------------------------------------|-----|-------------------------------------------|-----|-------------------------------------------|-----|-----------------------------------------|-----|------|
|           |                |             | MIN                                        | MAX | MIN                                       | MAX | MIN                                       | MAX | MIN                                     | MAX |      |
| Data rate |                |             | 40                                         |     | 40                                        |     | 40                                        |     | 40                                      |     | Mbps |
| $t_w$     | Pulse duration | Data inputs | 25                                         |     | 25                                        |     | 25                                        |     | 25                                      |     | ns   |

## 6.8 Timing Requirements: $V_{CCA} = 1.8\text{ V} \pm 0.15\text{ V}$

over recommended operating free-air temperature range,  $V_{CCA} = 1.8\text{ V} \pm 0.15\text{ V}$  (unless otherwise noted)

|           |                |             | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ |     | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ |     | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ |     | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ |     | UNIT |
|-----------|----------------|-------------|--------------------------------------------|-----|-------------------------------------------|-----|-------------------------------------------|-----|-----------------------------------------|-----|------|
|           |                |             | MIN                                        | MAX | MIN                                       | MAX | MIN                                       | MAX | MIN                                     | MAX |      |
| Data rate |                |             | 60                                         |     | 60                                        |     | 60                                        |     | 60                                      |     | Mbps |
| $t_w$     | Pulse duration | Data inputs | 17                                         |     | 17                                        |     | 17                                        |     | 17                                      |     | ns   |

## 6.9 Timing Requirements: $V_{CCA} = 2.5\text{ V} \pm 0.2\text{ V}$

over recommended operating free-air temperature range,  $V_{CCA} = 2.5\text{ V} \pm 0.2\text{ V}$  (unless otherwise noted)

|           |                |             | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ |     | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ |     | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ |     | UNIT |
|-----------|----------------|-------------|-------------------------------------------|-----|-------------------------------------------|-----|-----------------------------------------|-----|------|
|           |                |             | MIN                                       | MAX | MIN                                       | MAX | MIN                                     | MAX |      |
| Data rate |                |             | 100                                       |     | 100                                       |     | 100                                     |     | Mbps |
| $t_w$     | Pulse duration | Data inputs | 10                                        |     | 10                                        |     | 10                                      |     | ns   |

## 6.10 Timing Requirements: $V_{CCA} = 3.3\text{ V} \pm 0.3\text{ V}$

over recommended operating free-air temperature range,  $V_{CCA} = 3.3\text{ V} \pm 0.3\text{ V}$  (unless otherwise noted)

|           |                |             | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ |     | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ |     | UNIT |
|-----------|----------------|-------------|-------------------------------------------|-----|-----------------------------------------|-----|------|
|           |                |             | MIN                                       | MAX | MIN                                     | MAX |      |
| Data rate |                |             | 100                                       |     | 100                                     |     | Mbps |
| $t_w$     | Pulse duration | Data inputs | 10                                        |     | 10                                      |     | ns   |



## 6.11 Switching Characteristics: $V_{CCA} = 1.2\text{ V}$

 $T_A = 25^\circ\text{C}$ ,  $V_{CCA} = 1.2\text{ V}$ 

| PARAMETER                                            | TEST CONDITIONS            | $V_{CCB} = 1.8\text{ V}$ |     |     | $V_{CCB} = 2.5\text{ V}$ |     |     | $V_{CCB} = 3.3\text{ V}$ |     |     | $V_{CCB} = 5\text{ V}$ |     |     | UNIT          |
|------------------------------------------------------|----------------------------|--------------------------|-----|-----|--------------------------|-----|-----|--------------------------|-----|-----|------------------------|-----|-----|---------------|
|                                                      |                            | MIN                      | TYP | MAX | MIN                      | TYP | MAX | MIN                      | TYP | MAX | MIN                    | TYP | MAX |               |
| $t_{pd}$ Propagation delay time                      | A-to-B                     |                          | 6.9 |     |                          | 5.7 |     |                          | 5.3 |     |                        | 5.5 |     | ns            |
|                                                      | B-to-A                     |                          | 7.4 |     |                          | 6.4 |     |                          | 6   |     |                        | 5.8 |     |               |
| $t_{en}$ Enable time                                 | OE-to-A                    |                          | 1   |     |                          | 1   |     |                          | 1   |     |                        | 1   |     | $\mu\text{s}$ |
|                                                      | OE-to-B                    |                          | 1   |     |                          | 1   |     |                          | 1   |     |                        | 1   |     |               |
| $t_{dis}$ Disable time                               | OE-to-A                    |                          | 18  |     |                          | 15  |     |                          | 14  |     |                        | 14  |     | ns            |
|                                                      | OE-to-B                    |                          | 20  |     |                          | 17  |     |                          | 16  |     |                        | 16  |     |               |
| $t_{rA}$ , $t_{fA}$ Input rise time, input fall time | A-port rise and fall times |                          | 4.2 |     |                          | 4.2 |     |                          | 4.2 |     |                        | 4.2 |     | ns            |
| $t_{rB}$ , $t_{fB}$ Input rise time, input fall time | B-port rise and fall times |                          | 2.1 |     |                          | 1.5 |     |                          | 1.2 |     |                        | 1.1 |     | ns            |
| $t_{SK(O)}$ Skew (time), output                      | Channel-to-channel skew    |                          | 0.4 |     |                          | 0.5 |     |                          | 0.5 |     |                        | 1.4 |     | ns            |
| Maximum data rate                                    |                            |                          | 20  |     |                          | 20  |     |                          | 20  |     |                        | 20  |     | Mbps          |

## 6.12 Switching Characteristics: $V_{CCA} = 1.5\text{ V} \pm 0.1\text{ V}$

over recommended operating free-air temperature range,  $V_{CCA} = 1.5\text{ V} \pm 0.1\text{ V}$  (unless otherwise noted)

| PARAMETER                                            | TEST CONDITIONS            | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ |      | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ |      | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ |      | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ |      | UNIT          |
|------------------------------------------------------|----------------------------|--------------------------------------------|------|-------------------------------------------|------|-------------------------------------------|------|-----------------------------------------|------|---------------|
|                                                      |                            | MIN                                        | MAX  | MIN                                       | MAX  | MIN                                       | MAX  | MIN                                     | MAX  |               |
| $t_{pd}$ Propagation delay time                      | A-to-B                     | 1.4                                        | 12.9 | 1.2                                       | 10.1 | 1.1                                       | 10   | 0.8                                     | 9.9  | ns            |
|                                                      | B-to-A                     | 0.9                                        | 14.2 | 0.7                                       | 12   | 0.4                                       | 11.7 | 0.3                                     | 13.7 |               |
| $t_{en}$ Enable time                                 | OE-to-A                    |                                            | 1    |                                           | 1    |                                           | 1    |                                         | 1    | $\mu\text{s}$ |
|                                                      | OE-to-B                    |                                            | 1    |                                           | 1    |                                           | 1    |                                         | 1    |               |
| $t_{dis}$ Disable time                               | OE-to-A                    | 5.9                                        | 31   | 5.7                                       | 25.9 | 5.6                                       | 23   | 5.7                                     | 22.4 | ns            |
|                                                      | OE-to-B                    | 5.4                                        | 30.3 | 4.9                                       | 22.8 | 4.8                                       | 20   | 4.9                                     | 19.5 |               |
| $t_{rA}$ , $t_{fA}$ Input rise time, input fall time | A-port rise and fall times | 1.4                                        | 5.1  | 1.4                                       | 5.1  | 1.4                                       | 5.1  | 1.4                                     | 5.1  | ns            |
| $t_{rB}$ , $t_{fB}$ Input rise time, input fall time | B-port rise and fall times | 0.9                                        | 4.5  | 0.6                                       | 3.2  | 0.5                                       | 2.8  | 0.4                                     | 2.7  | ns            |
| $t_{SK(O)}$ Skew (time), output                      | Channel-to-channel skew    |                                            | 0.5  |                                           | 0.5  |                                           | 0.5  |                                         | 0.5  | ns            |
| Maximum data rate                                    |                            | 40                                         |      | 40                                        |      | 40                                        |      | 40                                      |      | Mbps          |

### 6.13 Switching Characteristics: $V_{CCA} = 1.8\text{ V} \pm 0.15\text{ V}$

over recommended operating free-air temperature range,  $V_{CCA} = 1.8\text{ V} \pm 0.15\text{ V}$  (unless otherwise noted)

| PARAMETER                                         | TEST CONDITIONS            | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ |      | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ |      | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ |      | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ |      | UNIT          |
|---------------------------------------------------|----------------------------|--------------------------------------------|------|-------------------------------------------|------|-------------------------------------------|------|-----------------------------------------|------|---------------|
|                                                   |                            | MIN                                        | MAX  | MIN                                       | MAX  | MIN                                       | MAX  | MIN                                     | MAX  |               |
| $t_{pd}$ Propagation delay time                   | A-to-B                     | 1.6                                        | 11   | 1.4                                       | 7.7  | 1.3                                       | 6.8  | 1.2                                     | 6.5  | ns            |
|                                                   | B-to-A                     | 1.5                                        | 12   | 1.3                                       | 8.4  | 1                                         | 7.6  | 0.9                                     | 7.1  |               |
| $t_{en}$ Enable time                              | OE-to-A                    |                                            | 1    |                                           | 1    |                                           | 1    |                                         | 1    | $\mu\text{s}$ |
|                                                   | OE-to-B                    |                                            | 1    |                                           | 1    |                                           | 1    |                                         | 1    |               |
| $t_{dis}$ Disable time                            | OE-to-A                    | 5.9                                        | 31   | 5.1                                       | 21.3 | 5                                         | 19.3 | 5                                       | 17.4 | ns            |
|                                                   | OE-to-B                    | 5.4                                        | 30.3 | 4.4                                       | 20.8 | 4.2                                       | 17.9 | 4.3                                     | 16.3 |               |
| $t_{rA}, t_{fA}$ Input rise time, input fall time | A-port rise and fall times | 1                                          | 4.2  | 1.1                                       | 4.1  | 1.1                                       | 4.1  | 1.1                                     | 4.1  | ns            |
| $t_{rB}, t_{fB}$ Input rise time, input fall time | B-port rise and fall times | 0.9                                        | 3.8  | 0.6                                       | 3.2  | 0.5                                       | 2.8  | 0.4                                     | 2.7  | ns            |
| $t_{SK(O)}$ Skew (time), output                   | Channel-to-channel skew    |                                            | 0.5  |                                           | 0.5  |                                           | 0.5  |                                         | 0.5  | ns            |
| Maximum data rate                                 |                            | 60                                         |      | 60                                        |      | 60                                        |      | 60                                      |      | Mbps          |

### 6.14 Switching Characteristics: $V_{CCA} = 2.5\text{ V} \pm 0.2\text{ V}$

over recommended operating free-air temperature range,  $V_{CCA} = 2.5\text{ V} \pm 0.2\text{ V}$  (unless otherwise noted)

| PARAMETER                                         | TEST CONDITIONS            | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ |      | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ |      | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ |      | UNIT          |
|---------------------------------------------------|----------------------------|-------------------------------------------|------|-------------------------------------------|------|-----------------------------------------|------|---------------|
|                                                   |                            | MIN                                       | MAX  | MIN                                       | MAX  | MIN                                     | MAX  |               |
| $t_{pd}$ Propagation delay time                   | A-to-B                     | 1.1                                       | 6.3  | 1                                         | 5.2  | 0.9                                     | 4.7  | ns            |
|                                                   | B-to-A                     | 1.2                                       | 6.6  | 1.1                                       | 5.1  | 0.9                                     | 4.4  |               |
| $t_{en}$ Enable time                              | OE-to-A                    |                                           | 1    |                                           | 1    |                                         | 1    | $\mu\text{s}$ |
|                                                   | OE-to-B                    |                                           | 1    |                                           | 1    |                                         | 1    |               |
| $t_{dis}$ Disable time                            | OE-to-A                    | 5.1                                       | 21.3 | 4.6                                       | 15.2 | 4.6                                     | 13.2 | ns            |
|                                                   | OE-to-B                    | 4.4                                       | 20.8 | 3.8                                       | 16   | 3.9                                     | 13.9 |               |
| $t_{rA}, t_{fA}$ Input rise time, input fall time | A-port rise and fall times | 0.8                                       | 3    | 0.8                                       | 3    | 0.8                                     | 3    | ns            |
| $t_{rB}, t_{fB}$ Input rise time, input fall time | B-port rise and fall times | 0.7                                       | 2.6  | 0.5                                       | 2.8  | 0.4                                     | 2.7  | ns            |
| $t_{SK(O)}$ Skew (time), output                   | Channel-to-channel skew    |                                           | 0.5  |                                           | 0.5  |                                         | 0.5  | ns            |
| Maximum data rate                                 |                            | 100                                       |      | 100                                       |      | 100                                     |      | Mbps          |

## 6.15 Switching Characteristics: $V_{CCA} = 3.3\text{ V} \pm 0.3\text{ V}$

over recommended operating free-air temperature range,  $V_{CCA} = 3.3\text{ V} \pm 0.3\text{ V}$  (unless otherwise noted)

| PARAMETER                                         | TEST CONDITIONS            | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ |      | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ |      | UNIT          |
|---------------------------------------------------|----------------------------|-------------------------------------------|------|-----------------------------------------|------|---------------|
|                                                   |                            | MIN                                       | MAX  | MIN                                     | MAX  |               |
| $t_{pd}$ Propagation delay time                   | A-to-B                     | 0.9                                       | 4.7  | 0.8                                     | 4    | ns            |
|                                                   | B-to-A                     | 1                                         | 4.9  | 0.9                                     | 3.8  |               |
| $t_{en}$ Enable time                              | OE-to-A                    |                                           | 1    |                                         | 1    | $\mu\text{s}$ |
|                                                   | OE-to-B                    |                                           | 1    |                                         | 1    |               |
| $t_{dis}$ Disable time                            | OE-to-A                    | 4.6                                       | 15.2 | 4.3                                     | 12.1 | ns            |
|                                                   | OE-to-B                    | 3.8                                       | 16   | 3.4                                     | 13.2 |               |
| $t_{rA}, t_{fA}$ Input rise time, input fall time | A-port rise and fall times | 0.7                                       | 2.5  | 0.7                                     | 2.5  | ns            |
| $t_{rB}, t_{fB}$ Input rise time, input fall time | B-port rise and fall times | 0.5                                       | 2.1  | 0.4                                     | 2.7  | ns            |
| $t_{SK(O)}$ Skew (time), output                   | Channel-to-channel skew    |                                           | 0.5  |                                         | 0.5  | ns            |
| Maximum data rate                                 |                            | 100                                       |      | 100                                     |      | Mbps          |

## 6.16 Operating Characteristics: $V_{CCA} = 1.2\text{ V to }1.5\text{ V}$ , $V_{CCB} = 1.5\text{ V to }1.8\text{ V}$

 $T_A = 25^\circ\text{C}$ 

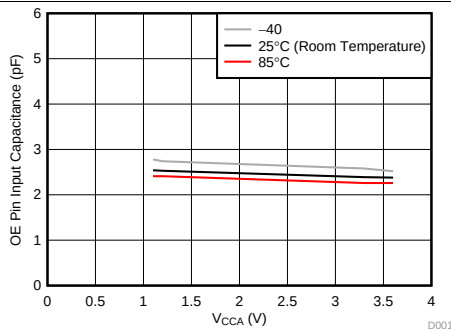
| PARAMETER        |                               | TEST CONDITIONS                                                                                                          |                             | V <sub>CCA</sub> = 1.2 V, V <sub>CCB</sub> =1.5 V |     |     | V <sub>CCA</sub> = 1.2 V, V <sub>CCB</sub> = 1.8 V |     |     | V <sub>CCA</sub> = 1.5 V, V <sub>CCB</sub> = 1.8 V |     |     | UNIT |
|------------------|-------------------------------|--------------------------------------------------------------------------------------------------------------------------|-----------------------------|---------------------------------------------------|-----|-----|----------------------------------------------------|-----|-----|----------------------------------------------------|-----|-----|------|
|                  |                               |                                                                                                                          |                             | MIN                                               | TYP | MAX | MIN                                                | TYP | MAX | MIN                                                | TYP | MAX |      |
| C <sub>pdA</sub> | Power dissipation capacitance | C <sub>L</sub> = 0<br>f = 10 MHz<br>t <sub>r</sub> = t <sub>f</sub> = 1 ns<br>OE = V <sub>CCA</sub><br>(outputs enabled) | A-port input, B-port output | 7.8                                               |     |     | 10                                                 |     |     | 9                                                  |     |     | pF   |
|                  |                               |                                                                                                                          | B-port input, A-port output | 12                                                |     |     | 11                                                 |     |     | 11                                                 |     |     |      |
| C <sub>pdB</sub> | Power dissipation capacitance |                                                                                                                          | A-port input, B-port output | 38.1                                              |     |     | 28                                                 |     |     | 28                                                 |     |     |      |
|                  |                               |                                                                                                                          | B-port input, A-port output | 25.4                                              |     |     | 19                                                 |     |     | 18                                                 |     |     |      |
| C <sub>pdA</sub> | Power dissipation capacitance | C <sub>L</sub> = 0<br>f = 10 MHz<br>t <sub>r</sub> = t <sub>f</sub> = 1 ns<br>OE = GND<br>(outputs disabled)             | A-port input, B-port output | 0.01                                              |     |     | 0.01                                               |     |     | 0.01                                               |     |     | pF   |
|                  |                               |                                                                                                                          | B-port input, A-port output | 0.01                                              |     |     | 0.01                                               |     |     | 0.01                                               |     |     |      |
| C <sub>pdB</sub> | Power dissipation capacitance |                                                                                                                          | A-port input, B-port output | 0.01                                              |     |     | 0.01                                               |     |     | 0.01                                               |     |     |      |
|                  |                               |                                                                                                                          | B-port input, A-port output | 0.01                                              |     |     | 0.01                                               |     |     | 0.01                                               |     |     |      |

## 6.17 Operating Characteristics: $V_{CCA} = 1.8\text{ V to }3.3\text{ V}$ , $V_{CCB} = 1.8\text{ V to }5\text{ V}$

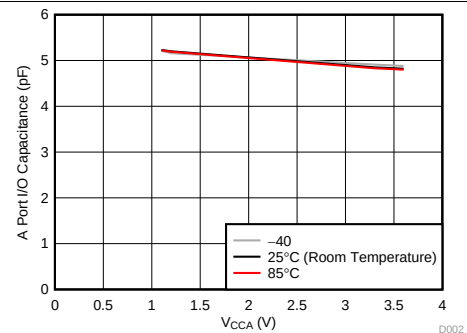
 $T_A = 25^\circ\text{C}$ 

| PARAMETER |                               | TEST CONDITIONS                                                                                          |                             | $V_{CCA} = 1.8\text{ V},$<br>$V_{CCB} = 1.8\text{ V}$ |     |     | $V_{CCA} = 2.5\text{ V},$<br>$V_{CCB} = 2.5\text{ V}$ |     |     | $V_{CCA} = 2.5\text{ V},$<br>$V_{CCB} = 5\text{ V}$ |     |     | $V_{CCA} = 3.3\text{ V},$<br>$V_{CCB} = 3.3\text{ V to }5\text{ V}$ |     |     | UNIT |
|-----------|-------------------------------|----------------------------------------------------------------------------------------------------------|-----------------------------|-------------------------------------------------------|-----|-----|-------------------------------------------------------|-----|-----|-----------------------------------------------------|-----|-----|---------------------------------------------------------------------|-----|-----|------|
|           |                               |                                                                                                          |                             | MIN                                                   | TYP | MAX | MIN                                                   | TYP | MAX | MIN                                                 | TYP | MAX | MIN                                                                 | TYP | MAX |      |
| $C_{pdA}$ | Power dissipation capacitance | $C_L = 0$<br>$f = 10\text{ MHz}$<br>$t_r = t_f = 1\text{ ns}$<br>$OE = V_{CCA}$<br>(outputs enabled)     | A-port input, B-port output | 8                                                     |     |     | 8                                                     |     |     | 8                                                   |     |     | 9                                                                   |     |     | pF   |
|           |                               |                                                                                                          | B-port input, A-port output | 11                                                    |     |     | 11                                                    |     |     | 11                                                  |     |     | 11                                                                  |     |     |      |
| $C_{pdB}$ | Power dissipation capacitance |                                                                                                          | A-port input, B-port output | 28                                                    |     |     | 29                                                    |     |     | 29                                                  |     |     | 29                                                                  |     |     |      |
|           |                               |                                                                                                          | B-port input, A-port output | 18                                                    |     |     | 19                                                    |     |     | 21                                                  |     |     | 22                                                                  |     |     |      |
| $C_{pdA}$ | Power dissipation capacitance | $C_L = 0$<br>$f = 10\text{ MHz}$<br>$t_r = t_f = 1\text{ ns}$<br>$OE = \text{GND}$<br>(outputs disabled) | A-port input, B-port output | 0.01                                                  |     |     | 0.01                                                  |     |     | 0.01                                                |     |     | 0.01                                                                |     |     | pF   |
|           |                               |                                                                                                          | B-port input, A-port output | 0.01                                                  |     |     | 0.01                                                  |     |     | 0.01                                                |     |     | 0.01                                                                |     |     |      |
| $C_{pdB}$ | Power dissipation capacitance |                                                                                                          | A-port input, B-port output | 0.01                                                  |     |     | 0.01                                                  |     |     | 0.01                                                |     |     | 0.03                                                                |     |     |      |
|           |                               |                                                                                                          | B-port input, A-port output | 0.01                                                  |     |     | 0.01                                                  |     |     | 0.01                                                |     |     | 0.04                                                                |     |     |      |

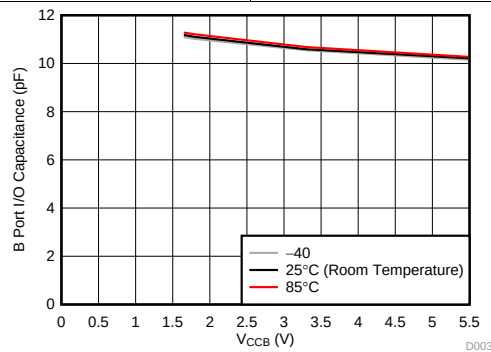
## 6.18 Typical Characteristics



**Figure 1. Input Capacitance for OE Pin ( $C_i$ ) vs Power Supply ( $V_{CCA}$ )**



**Figure 2. Capacitance for A port I/O Pins ( $C_{IO}$ ) vs Power Supply ( $V_{CCA}$ )**



**Figure 3. Capacitance for B Port I/O Pins ( $C_{IO}$ ) vs Power Supply ( $V_{CCB}$ )**

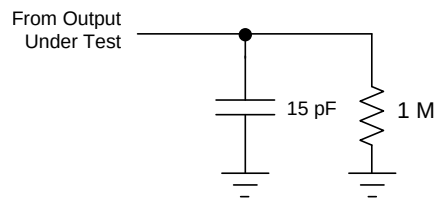
## 7 Parameter Measurement Information

Unless otherwise noted, all input pulses are supplied by generators that have the following characteristics:

- PRR 10 MHz
- $Z_O = 50\ \Omega$
- $dv/dt \geq 1\ \text{V/ns}$

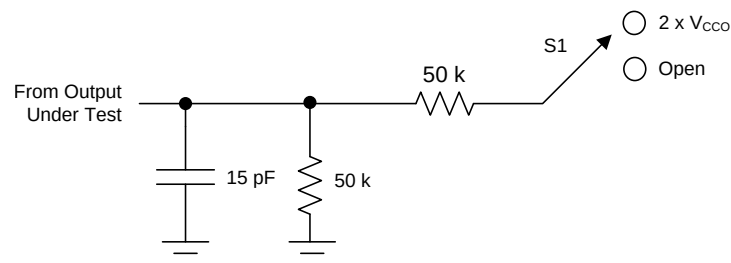
### NOTE

All parameters and waveforms are not applicable to all devices.



- (1) The outputs are measured one at a time, with one transition per measurement.

**Figure 4. Load Circuit For Maximum Data Rate: Pulse Duration, Propagation Delay Output Rise, And Fall Time Measurement**

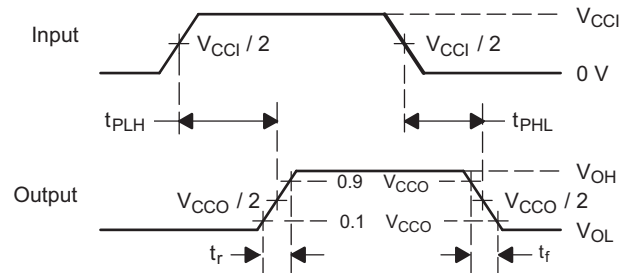


- (1) The outputs are measured one at a time, with one transition per measurement.

**Figure 5. Load Circuit For Enable / Disable Time Measurement**

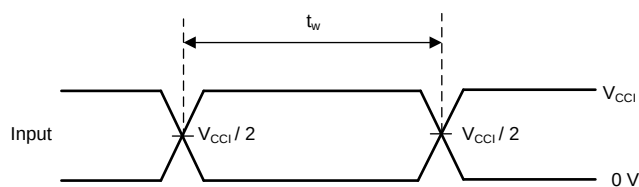
**Table 1. Switch Position For Enable / Disable Time Measurement (See Figure 5)**

| TEST               | S1                 |
|--------------------|--------------------|
| $t_{PZL}, t_{PLZ}$ | $2 \times V_{CCO}$ |
| $t_{PHZ}, t_{PZH}$ | Open               |



- (1)  $V_{CCI}$  is the  $V_{CC}$  associated with the input port.
- (2)  $V_{CCO}$  is the  $V_{CC}$  associated with the output port.
- (3)  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
- (4) The outputs are measured one at a time, with one transition per measurement.

**Figure 6. Voltage Waveforms Propagation Delay Times**



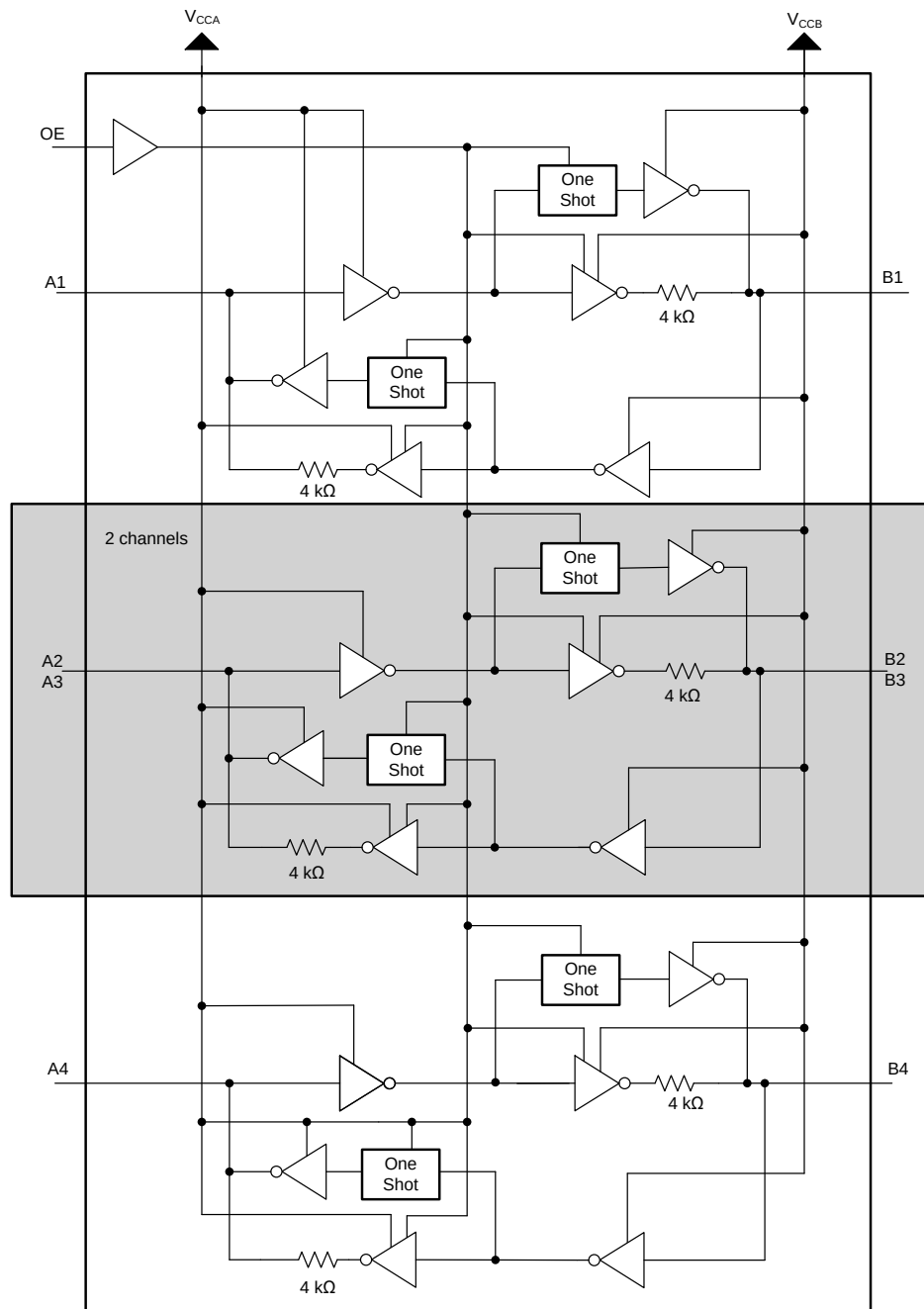
**Figure 7. Voltage Waveforms Pulse Duration**

## 8 Detailed Description

### 8.1 Overview

The TXB0104 device is a 4-bit, directionless voltage-level translator specifically designed for translating logic voltage levels. The A port is able to accept I/O voltages ranging from 1.2 V to 3.6 V, while the B port can accept I/O voltages from 1.65 V to 5.5 V. The device is a buffered architecture with edge-rate accelerators (one-shots) to improve the overall data rate. This device can only translate push-pull CMOS logic outputs. If for open-drain signal translation, please refer to TI's TXS010X products.

### 8.2 Functional Block Diagram





## 8.3 Feature Description

### 8.3.1 Architecture

The TXB0104 device architecture (see [Figure 8](#)) does not require a direction-control signal to control the direction of data flow from A to B or from B to A. In a DC state, the output drivers of the device maintain a high or low, but are designed to be weak, so the output drivers can be overdriven by an external driver when data on the bus flows the opposite direction.

The output one-shots detect rising or falling edges on the A or B ports. During a rising edge, the one-shot turns on the PMOS transistors (T1, T3) for a short duration, which speeds up the low-to-high transition. Similarly, during a falling edge, the one-shot turns on the NMOS transistors (T2, T4) for a short duration, which speeds up the high-to-low transition. The typical output impedance during output transition is 70  $\Omega$  at  $V_{CCO} = 1.2\text{ V}$  to 1.8 V, 50  $\Omega$  at  $V_{CCO} = 1.8\text{ V}$  to 3.3 V, and 40  $\Omega$  at  $V_{CCO} = 3.3\text{ V}$  to 5 V.

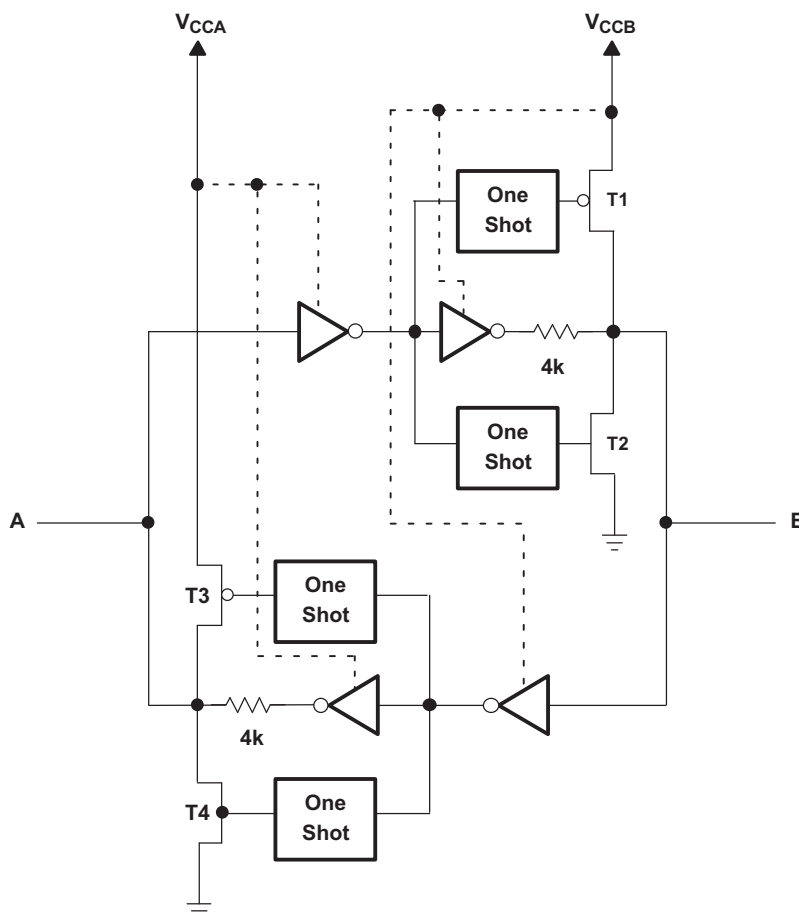
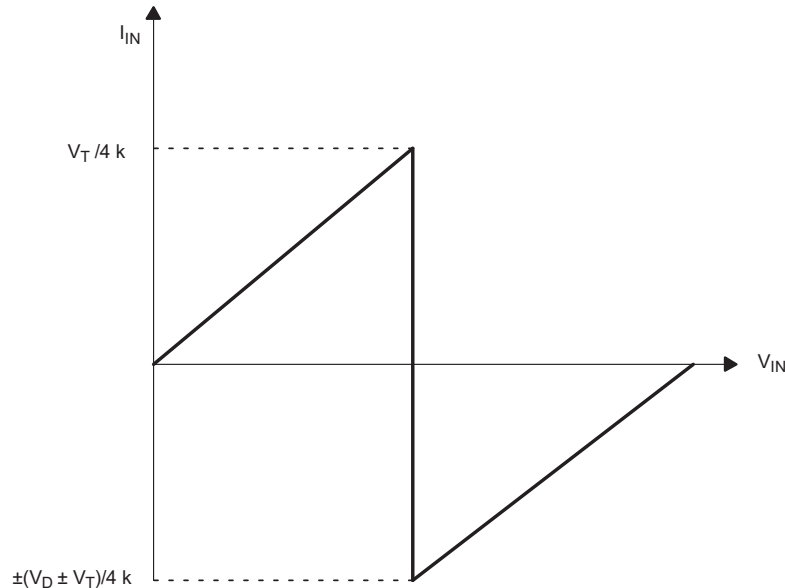


Figure 8. Architecture of TXB0104 Device I/O Cell

## Feature Description (continued)

### 8.3.2 Input Driver Requirements

Typical  $I_{IN}$  vs  $V_{IN}$  characteristics of the device are shown in Figure 9. For proper operation, the device driving the data I/Os of the TXB0104 device must have drive strength of at least  $\pm 2$  mA.



- (1)  $V_T$  is the input threshold of the TXB0104 device, (typically  $V_{CC} / 2$ ).
- (2)  $V_D$  is the supply voltage of the external driver.

**Figure 9. Typical  $I_{IN}$  vs  $V_{IN}$  Curve**

### 8.3.3 Output Load Considerations

TI recommends careful PCB layout practices with short PCB trace lengths to avoid excessive capacitive loading and to ensure that proper O.S. triggering takes place. PCB signal trace-lengths must be kept short enough such that the round trip delay of any reflection is less than the one-shot duration. This improves signal integrity by ensuring that any reflection sees a low impedance at the driver. The O.S. circuits have been designed to stay on for approximately 10 ns. The maximum capacitance of the lumped load that can be driven also depends directly on the one-shot duration. With very heavy capacitive loads, the one-shot can time-out before the signal is driven fully to the positive rail. The O.S. duration has been set to best optimize trade-offs between dynamic ICC, load driving capability, and maximum bit-rate considerations. Both PCB trace length and connectors add to the capacitance that the device output sees, so it is recommended that this lumped-load capacitance be considered to avoid O.S. retriggering, bus contention, output signal oscillations, or other adverse system-level affects.

## Feature Description (continued)

### 8.3.4 Enable and Disable

The TXB0104 device has an OE input that is used to disable the device by setting OE = low, which places all I/Os in the high-impedance (Hi-Z) state. The disable time ( $t_{dis}$ ) indicates the delay between when OE goes low and when the outputs actually get disabled (Hi-Z). The enable time ( $t_{en}$ ) indicates the amount of time the user must allow for the one-shot circuitry to become operational after OE is taken high.

### 8.3.5 Pullup or Pulldown Resistors on I/O Lines

The device is designed to drive capacitive loads of up to 70 pF. The output drivers of the TXB0104 device have low dc drive strength. If pullup or pulldown resistors are connected externally to the data I/Os, their values must be kept higher than 50 k $\Omega$  to ensure that they do not contend with the output drivers of the TXB0104 device.

For the same reason, the TXB0104 device must not be used in applications such as I<sup>2</sup>C or 1-Wire where an open-drain driver is connected on the bidirectional data I/O. For these applications, use a device from the TI TXS01xx series of level translators.

## 8.4 Device Functional Modes

The device has two functional modes, enabled and disabled. To disable the device, set the OE input to low, which places all I/Os in a high impedance state. Setting the OE input to high will enable the device.

## 9 Application and Implementation

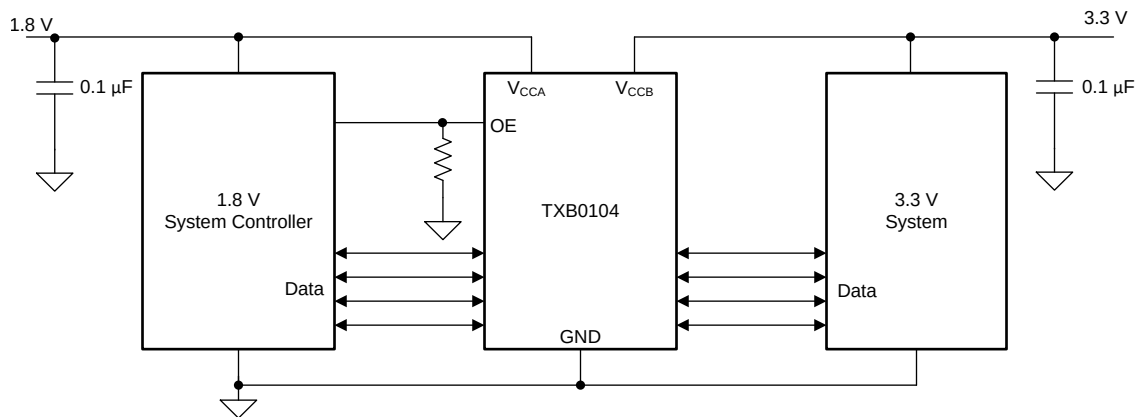
### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers must validate and test their design implementation to confirm system functionality.

### 9.1 Application Information

The TXB0104 device can be used in level-translation applications for interfacing devices or systems operating at different interface voltages with one another. It can only translate push-pull CMOS logic outputs. If for open-drain signal translation, please refer to TI TXS010X products. Any external pulldown or pullup resistors are recommended larger than 50 kΩ.

### 9.2 Typical Application



#### 9.2.1 Design Requirements

For this design example, use the parameters listed in [Table 2](#). And make sure the  $V_{CCA} \leq V_{CCB}$ .

**Table 2. Design Parameters**

| DESIGN PARAMETERS    | EXAMPLE VALUE   |
|----------------------|-----------------|
| Input voltage range  | 1.2 V to 3.6 V  |
| Output voltage range | 1.65 V to 5.5 V |

## 9.2.2 Detailed Design Procedure

To begin the design process, determine the following:

- Input voltage range
  - Use the supply voltage of the device that is driving the TXB0104 device to determine the input voltage range. For a valid logic high, the value must exceed the  $V_{IH}$  of the input port. For a valid logic low, the value must be less than the  $V_{IL}$  of the input port.
- Output voltage range
  - Use the supply voltage of the device that the device is driving to determine the output voltage range.
  - External pullup or pulldown resistors are not recommended. If mandatory, it is recommended that the value must be larger than 50 k $\Omega$ .
- An external pulldown or pullup resistor decreases the output  $V_{OH}$  and  $V_{OL}$ . Use the below equations to draft estimate the  $V_{OH}$  and  $V_{OL}$  as a result of an external pulldown and pullup resistor.

$$V_{OH} = V_{CCX} \times R_{PD} / (R_{PD} + 4.5 \text{ k}\Omega)$$

$$V_{OL} = V_{CCX} \times 4.5 \text{ k}\Omega / (R_{PU} + 4.5 \text{ k}\Omega)$$

Where

- $V_{CCX}$  is the output port supply voltage on either  $V_{CCA}$  or  $V_{CCB}$
- $R_{PD}$  is the value of the external pull down resistor
- $R_{PU}$  is the value of the external pull up resistor
- 4.5 k $\Omega$  is the counting the variation of the serial resistor 4 k $\Omega$  in the I/O line.

## 9.2.3 Application Curves

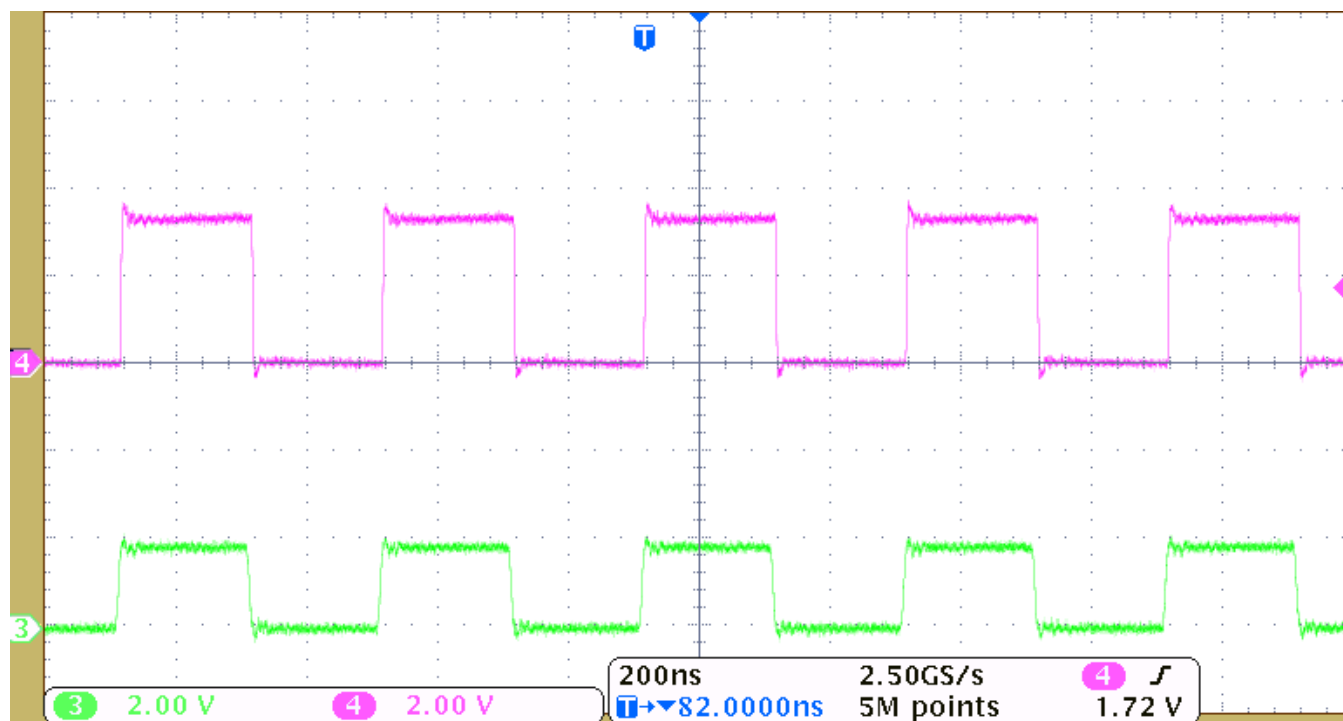


Figure 10. Level-Translation of a 2.5-MHz Signal

## 10 Power Supply Recommendations

During operation, ensure that  $V_{CCA} \leq V_{CCB}$  at all times. During power-up sequencing,  $V_{CCA} \geq V_{CCB}$  does not damage the device, so any power supply can be ramped up first. The device has circuitry that disables all output ports when either  $V_{CC}$  is switched off ( $V_{CCA/B} = 0$  V). The output-enable (OE) input circuit is designed so that it is supplied by  $V_{CCA}$  and when the (OE) input is low, all outputs are placed in the high-impedance state. To ensure the high-impedance state of the outputs during power up or power down, the OE input pin must be tied to GND through a pulldown resistor and must not be enabled until  $V_{CCA}$  and  $V_{CCB}$  are fully ramped and stable. The minimum value of the pulldown resistor to ground is determined by the current-sourcing capability of the driver.

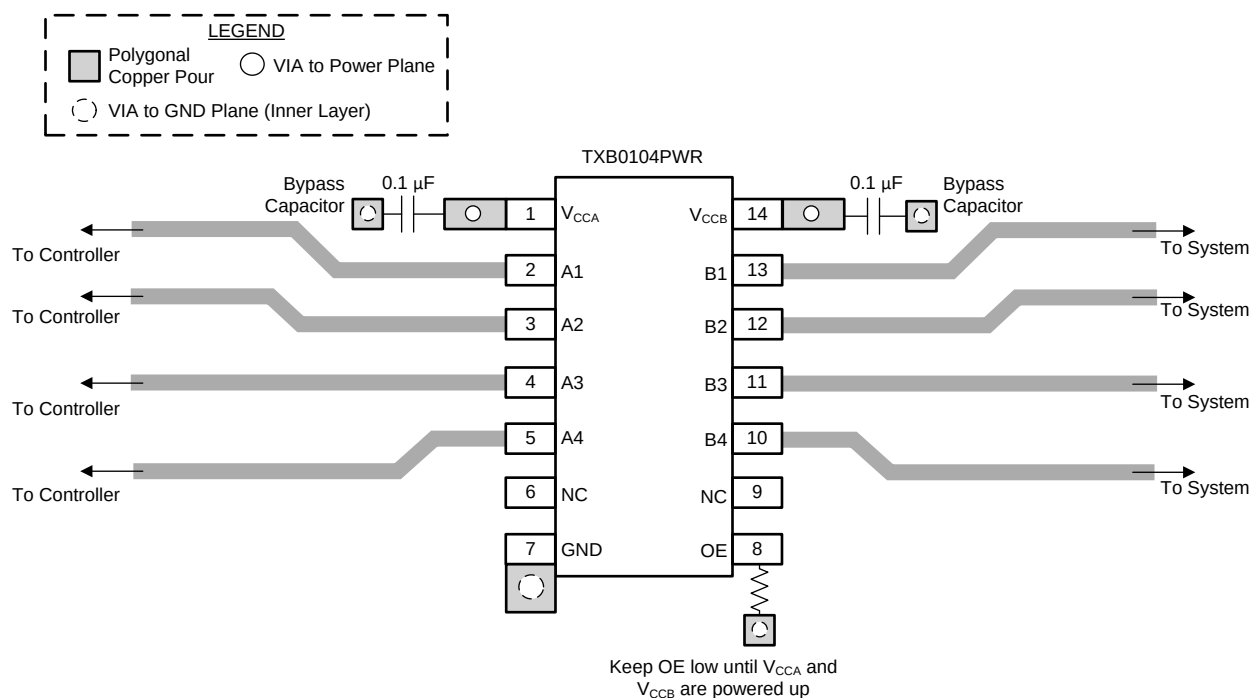
## 11 Layout

### 11.1 Layout Guidelines

To ensure reliability of the device, following common printed-circuit board layout guidelines is recommended.

- Bypass capacitors must be used on power supplies, and must be placed as close as possible to the  $V_{CCA}$ ,  $V_{CCB}$  pin and GND pin.
- Short trace-lengths must be used to avoid excessive loading.
- PCB signal trace-lengths must be kept short enough so that the round-trip delay of any reflection is less than the one-shot duration, approximately 10 ns, ensuring that any reflection encounters low impedance at the source driver.

### 11.2 Layout Example



## 12 Device and Documentation Support

### 12.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](http://ti.com). In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 12.2 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

**TI E2E™ Online Community** *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At [e2e.ti.com](http://e2e.ti.com), you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

### 12.3 Trademarks

E2E is a trademark of Texas Instruments.

is a trademark of ~ Texas Instruments.

All other trademarks are the property of their respective owners.

### 12.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 12.5 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 13 Mechanical, Packaging, and Orderable Information

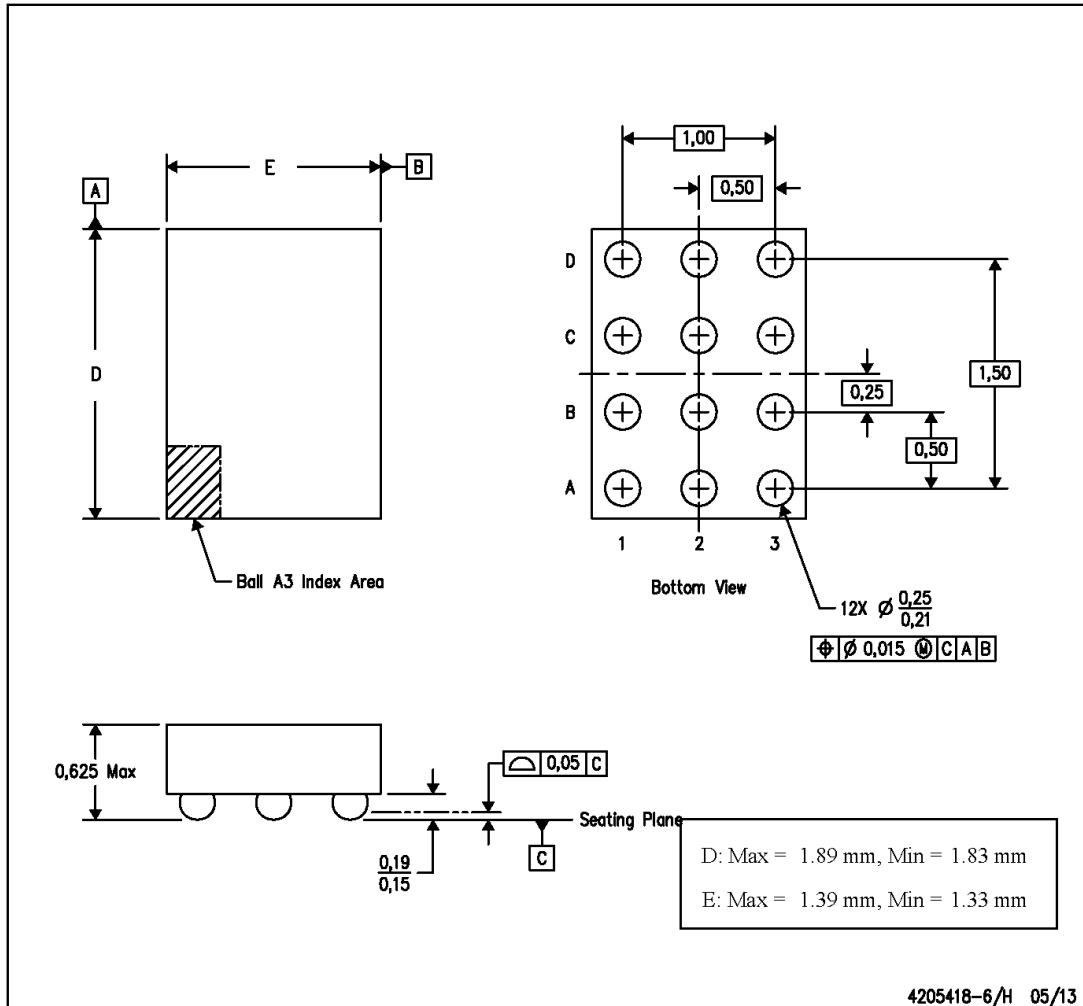
The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



## MECHANICAL DATA

YZT (R-XBGA-N12)

(CUSTOM) DIE-SIZE BALL GRID ARRAY



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. NanoFree™ package configuration.

NanoFree is a trademark of Texas Instruments.

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type               | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|----------------------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| HPA01164RUTR     | ACTIVE        | UQFN                       | RUT                | 12   | 3000           | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-1-260C-UNLIM   | -40 to 85    | (2KR, 2KV)              | <a href="#">Samples</a> |
| TXB0104D         | ACTIVE        | SOIC                       | D                  | 14   | 50             | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-1-260C-UNLIM   | -40 to 85    | TXB0104                 | <a href="#">Samples</a> |
| TXB0104DG4       | ACTIVE        | SOIC                       | D                  | 14   | 50             | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-1-260C-UNLIM   | -40 to 85    | TXB0104                 | <a href="#">Samples</a> |
| TXB0104DR        | ACTIVE        | SOIC                       | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-1-260C-UNLIM   | -40 to 85    | TXB0104                 | <a href="#">Samples</a> |
| TXB0104DRG4      | ACTIVE        | SOIC                       | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-1-260C-UNLIM   | -40 to 85    | TXB0104                 | <a href="#">Samples</a> |
| TXB0104PWR       | ACTIVE        | TSSOP                      | PW                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-1-260C-UNLIM   | -40 to 85    | YE04                    | <a href="#">Samples</a> |
| TXB0104PWRG4     | ACTIVE        | TSSOP                      | PW                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-1-260C-UNLIM   | -40 to 85    | YE04                    | <a href="#">Samples</a> |
| TXB0104RGYR      | ACTIVE        | VQFN                       | RGY                | 14   | 3000           | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-2-260C-1 YEAR  | -40 to 85    | YE04                    | <a href="#">Samples</a> |
| TXB0104RGYRG4    | ACTIVE        | VQFN                       | RGY                | 14   | 3000           | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-2-260C-1 YEAR  | -40 to 85    | YE04                    | <a href="#">Samples</a> |
| TXB0104RUTR      | ACTIVE        | UQFN                       | RUT                | 12   | 3000           | Green (RoHS<br>& no Sb/Br) | NIPDAU   NIPDAUAG       | Level-1-260C-UNLIM   | -40 to 85    | (2KR, 2KV)              | <a href="#">Samples</a> |
| TXB0104YZTR      | ACTIVE        | DSBGA                      | YZT                | 12   | 3000           | Green (RoHS<br>& no Sb/Br) | SNAGCU                  | Level-1-260C-UNLIM   | -40 to 85    | (2K, 2K7)               | <a href="#">Samples</a> |
| TXB0104ZXUR      | ACTIVE        | BGA<br>MICROSTAR<br>JUNIOR | ZXU                | 12   | 2500           | Green (RoHS<br>& no Sb/Br) | SNAGCU                  | Level-1-260C-UNLIM   | -40 to 85    | YE04                    | <a href="#">Samples</a> |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of  $\leq 1000$ ppm threshold. Antimony trioxide based flame retardants must also meet the  $\leq 1000$ ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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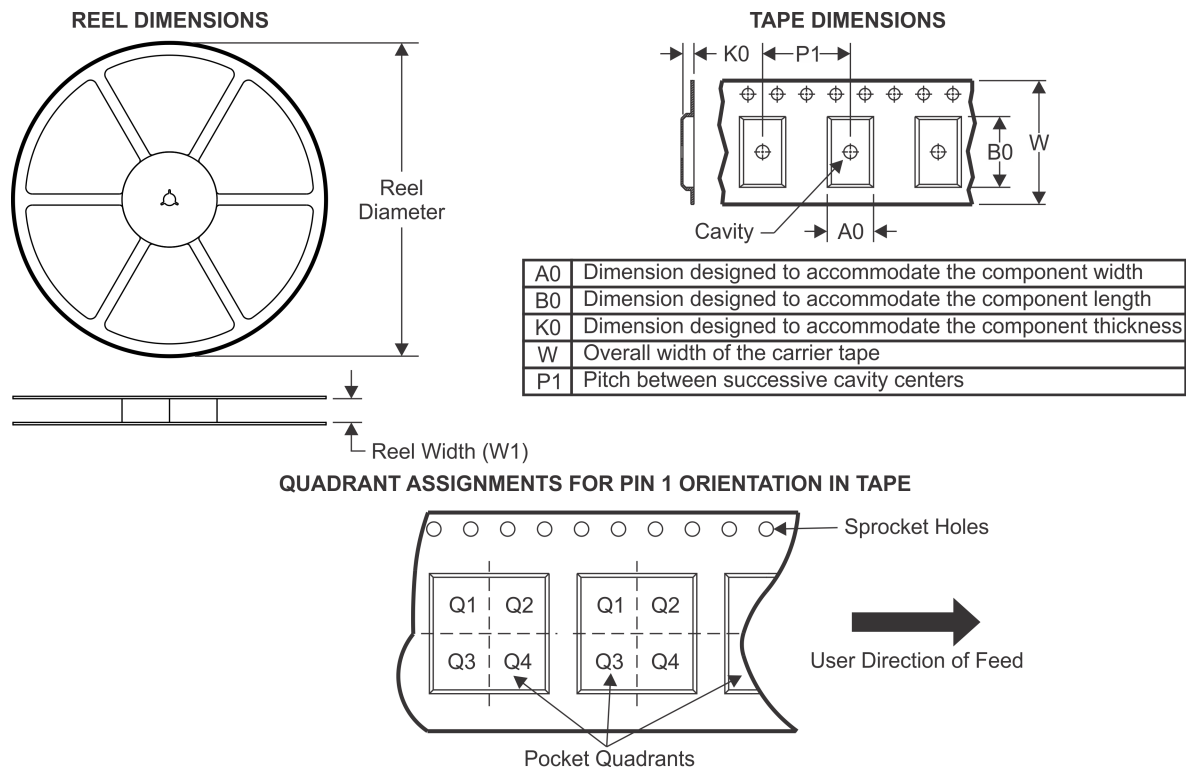
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF TXB0104 :**

- Automotive: [TXB0104-Q1](#)

NOTE: Qualified Version Definitions:

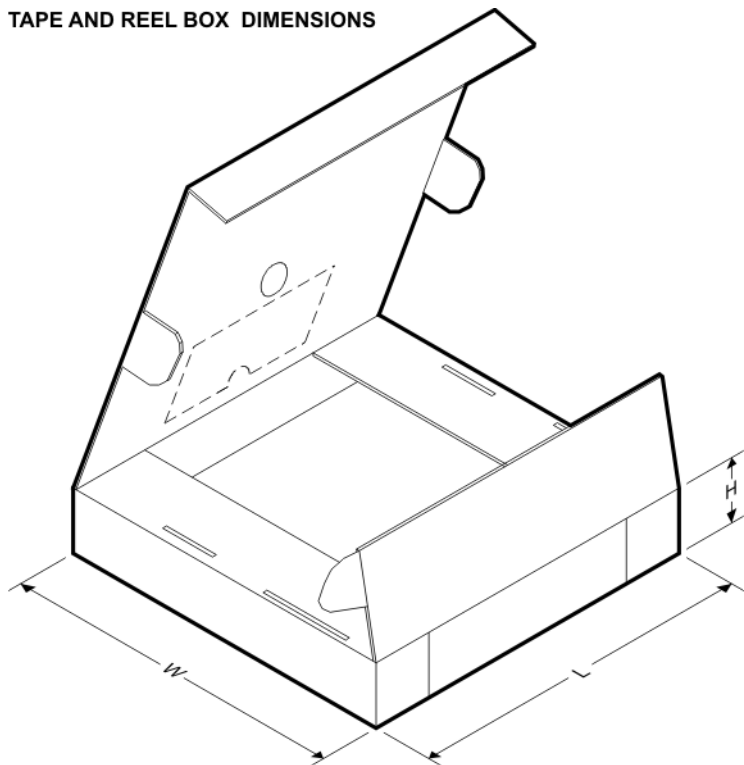
- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device      | Package Type         | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|----------------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TXB0104DR   | SOIC                 | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| TXB0104PWR  | TSSOP                | PW              | 14   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| TXB0104RGYR | VQFN                 | RGY             | 14   | 3000 | 330.0              | 12.4               | 3.75    | 3.75    | 1.15    | 8.0     | 12.0   | Q1            |
| TXB0104RUTR | UQFN                 | RUT             | 12   | 3000 | 180.0              | 9.5                | 1.9     | 2.2     | 0.7     | 4.0     | 8.0    | Q1            |
| TXB0104RUTR | UQFN                 | RUT             | 12   | 3000 | 180.0              | 8.4                | 1.95    | 2.3     | 0.75    | 4.0     | 8.0    | Q1            |
| TXB0104YZTR | DSBGA                | YZT             | 12   | 3000 | 180.0              | 8.4                | 1.49    | 1.99    | 0.75    | 4.0     | 8.0    | Q2            |
| TXB0104ZXUR | BGA MICROSTAR JUNIOR | ZXU             | 12   | 2500 | 330.0              | 8.4                | 2.3     | 2.8     | 1.0     | 4.0     | 8.0    | Q2            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device      | Package Type         | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|----------------------|-----------------|------|------|-------------|------------|-------------|
| TXB0104DR   | SOIC                 | D               | 14   | 2500 | 367.0       | 367.0      | 38.0        |
| TXB0104PWR  | TSSOP                | PW              | 14   | 2000 | 367.0       | 367.0      | 35.0        |
| TXB0104RGYR | VQFN                 | RGY             | 14   | 3000 | 367.0       | 367.0      | 35.0        |
| TXB0104RUTR | UQFN                 | RUT             | 12   | 3000 | 189.0       | 185.0      | 36.0        |
| TXB0104RUTR | UQFN                 | RUT             | 12   | 3000 | 202.0       | 201.0      | 28.0        |
| TXB0104YZTR | DSBGA                | YZT             | 12   | 3000 | 182.0       | 182.0      | 20.0        |
| TXB0104ZXUR | BGA MICROSTAR JUNIOR | ZXU             | 12   | 2500 | 350.0       | 350.0      | 43.0        |

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